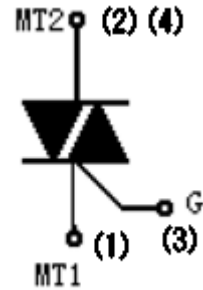


# LTspice Model

## Triac

### RENESAS

### BCR30AM-12LB



#### Model Information

**Model** A macro model  
**Call Name** MDC\_BCR30AM-12LB\_LT  
**Pin Assign** 1:T1 2:T2 3:G 4:T2(tab)  
**File List** Model Library MDC\_BCR30AM-12LB\_LT01.lib  
 Model Report MDC\_BCR30AM-12LB\_LT.pdf (this file)

**Verified Simulator Version** LTspice version XVII  
**Note**

#### References

The information which was used for modeling is as follow:

[Data Sheet]

- Date/Version Rev.3.00 Nov 30, 2007
- Product name BCR30AM-12LB
- Company name Renesas Electronics Corporation
- Characteristics ItmVtm[Temp], NormIgtTemp[Pname], NormIdrmTemp, Norm BvTemp, NormIdrmTemp, NormHoldTemp, SineWaveform, Sw itchingTgt

#### Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Reverse Voltage	0	to	600	V
Temperature	-40	to	150	deg C

## Thyristor or Triac

○ : Implemented  
× : Not Implemented  
— : Not applicable

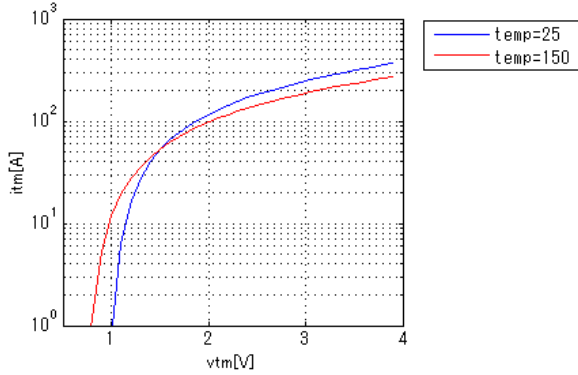
**Model Functions Table**
**RANK=1**

Functions	RANK	Implemented
Itm-Vtm(Temp)	1	○
Igt-Temp	1	○
Vgt-Temp	1	○
Bvover-Temp	1	○
Idrm-Temp	1	○
Latch Hold	1	○
Tgt	1	—

Simulation results are following.  
 Explanatory notes — : simulated

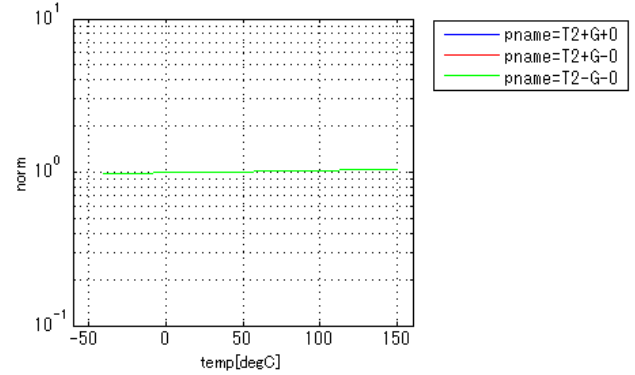
**ItmVtm[Temp]**

vgt. = 1V



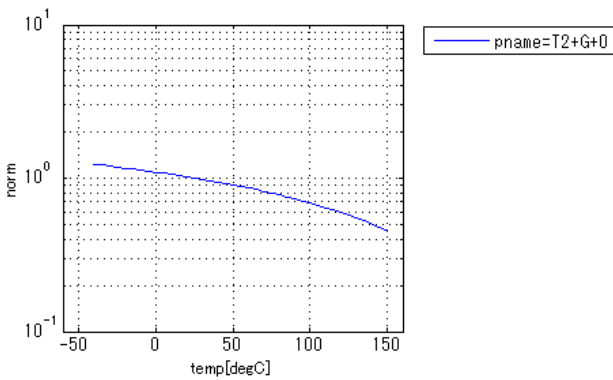
**NormIgtTemp[Pname]**

vgt. = 2.5V, vdm. = 6V, rl. = 6ohm, rg. = 330ohm

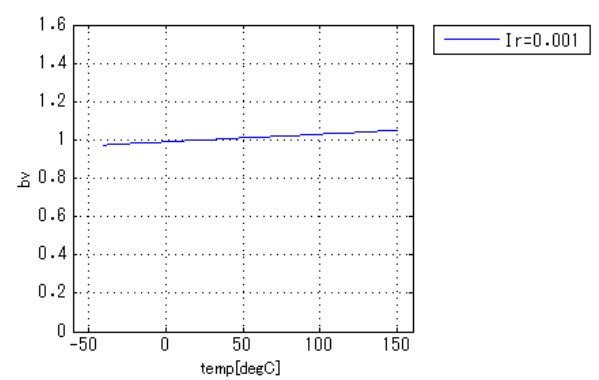


**NormIgtTemp[Pname]**

igt. = 0.05V, vdm. = 6V, rl. = 6ohm, rg. = 330ohm

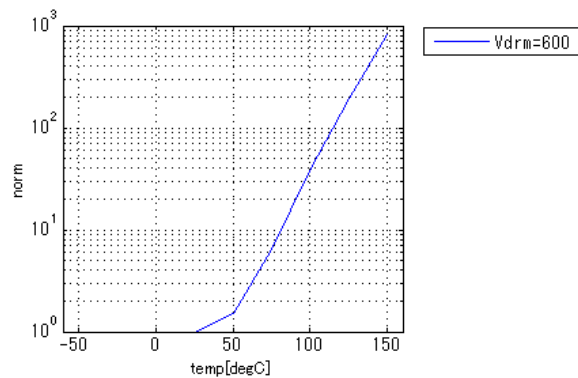


**NormBvTemp**



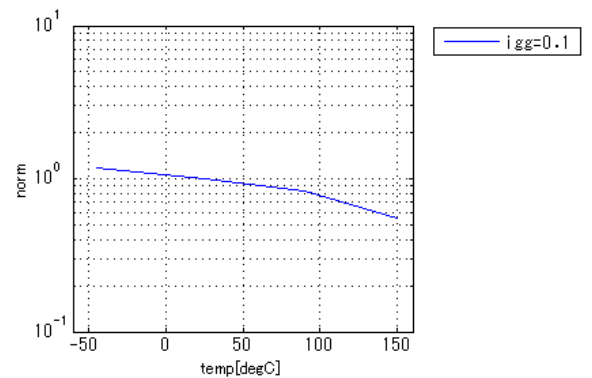
**NormIdrmTemp**

vdrm. = 600V



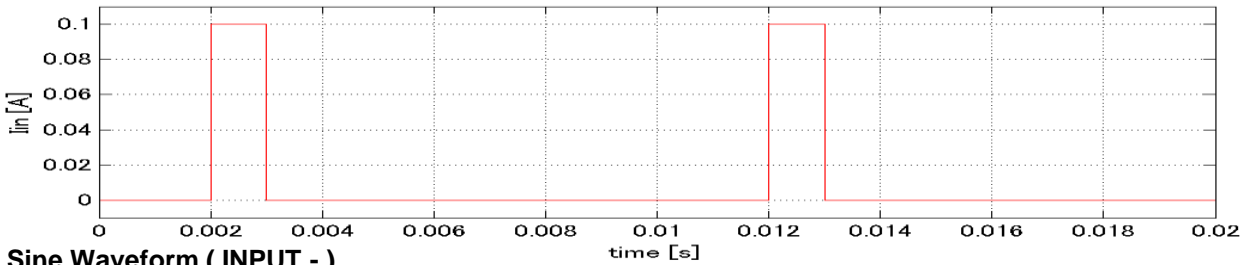
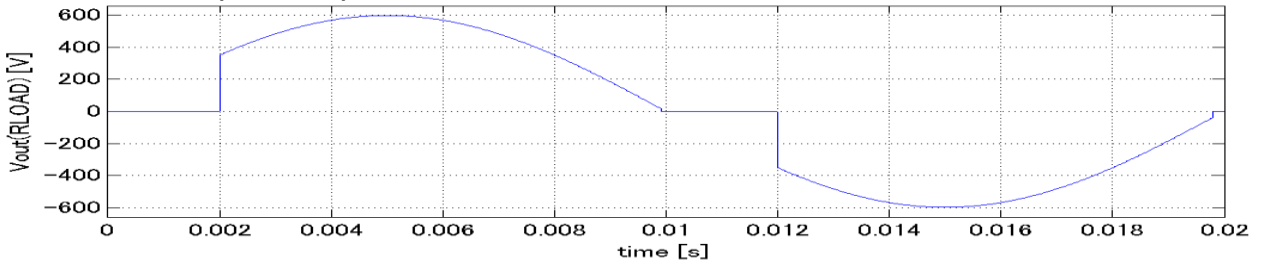
**NormHoldTemp**

igg. = 0.1A, vdd. = 6V

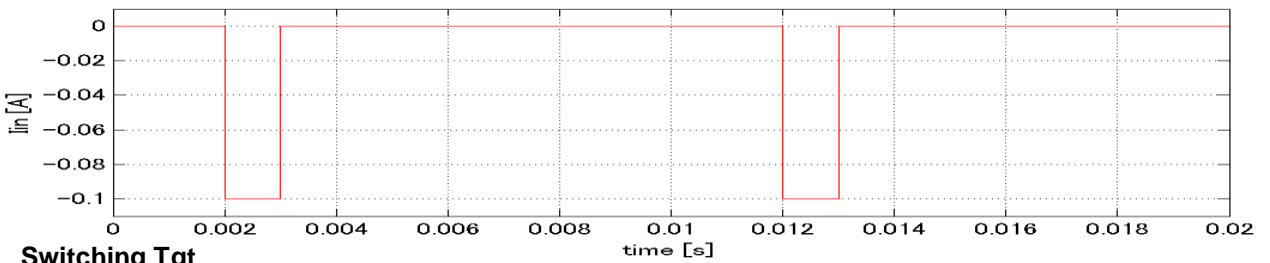
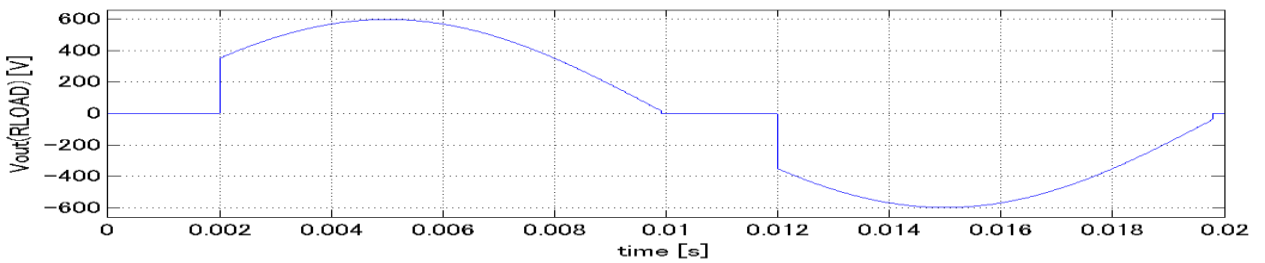


Simulation results are following.  
 Explanatory notes — : simulated

**Sine Waveform ( INPUT + )**

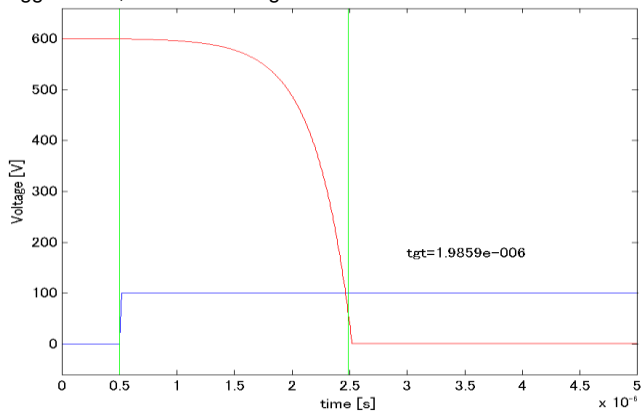


**Sine Waveform ( INPUT - )**



**Switching Tgt**

igg. = 0.1A, vdd. = 600V digdt = 5A/us



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